

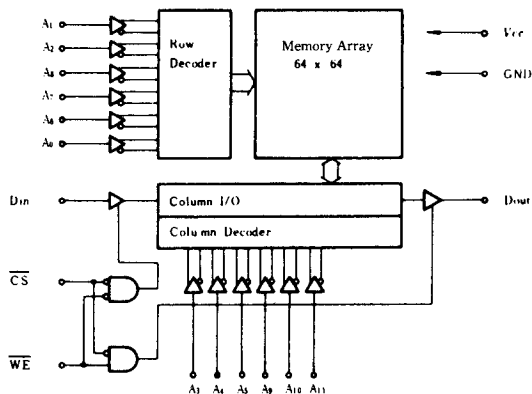
# HM6147H-35, HM6147H-45, HM6147H-55, HM6147HP-35, HM6147HP-45, HM6147HP-55

4096-word×1-bit High Speed Static CMOS RAM

## ■FEATURES

- High Speed: Fast Access Time 35ns/45ns/55ns Max.
- Low Power Standby and Low Power Operation, Standby: 100μW typ., Operation: 150mW typ.
- Single 5V Supply and High Density 18 Pin Package
- Completely Static Memory – No Clock nor Timing Strobe Required
- No Peak Power–On Current
- No Change of  $t_{ACS}$  with Short Chip Deselect Time
- Equal Access and Cycle Time
- Directly TTL Compatible – All Input and Output
- Separate Data Input and Output: Three State Output
- Plug-In Replacement with Intel 2147H NMOS STATIC RAM

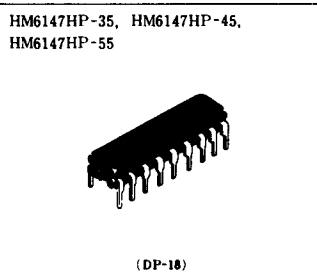
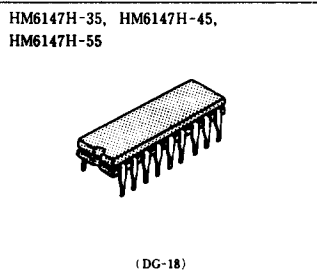
## ■BLOCK DIAGRAM



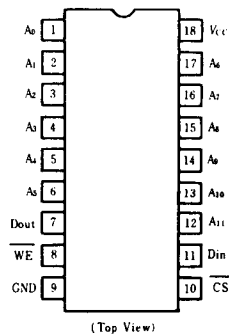
## ■ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on Any Pin relative to GND	$V_T$	-3.5* to +7.0	V
DC Output Current	$I_o$	20	mA
Power Dissipation	$P_T$	1.0	W
Operating Temperature	$T_{op}$	0 to +70	°C
Storage Temperature (under bias)	$T_{stg(bias)}$	-10 to +85	°C
Storage Temperature (Ceramic)	$T_{stg}$	-65 to +150	°C
Storage Temperature (Plastic)	$T_{stg}$	-55 to +125	°C

\* Pulse Width 20ns, DC: -0.5V



## ■PIN ARRANGEMENT



RECOMMENDED DC OPERATING CONDITIONS (0°C ≤ Ta ≤ 70°C)

Parameter	Symbol	min	typ	max	Unit
Supply Voltage	V <sub>CC</sub>	4.5	5.0	5.5	V
	GND	0	0	0	V
Input High (logic 1) Voltage	V <sub>IH</sub>	2.0	3.0	6.0	V
Input Low (logic 0) Voltage	V <sub>IL</sub>	-3.0*	-	0.8	V

\* Pulse Width 20ns, DC: -0.5V

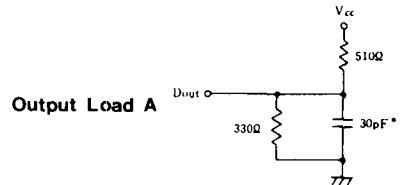
DC AND OPERATING CHARACTERISTICS (0°C ≤ Ta ≤ 70°C, V<sub>CC</sub> = 5V ± 10%, GND = 0V)

Parameter	Symbol	Test Condition	min	typ	max	Unit
Input Leakage Current	I <sub>LI</sub>	V <sub>CC</sub> = 5.5V, GND to V <sub>CC</sub>	-	-	10	μA
Output Leakage Current	I <sub>LO</sub>	CS = V <sub>IH</sub> , V <sub>out</sub> = 0V ~ V <sub>CC</sub>	-	-	10	μA
Operating Power Supply Current(1)	I <sub>CC</sub>	CS = V <sub>IL</sub> , Output open	-	30	80	mA
Operating Power Supply Current(2)	I <sub>CC1</sub>	CS = V <sub>IL</sub> , Minimum Cycle	-	40	80	mA
Standby Power Supply Current(1)	I <sub>SB</sub>	CS = V <sub>IH</sub> , V <sub>CC</sub> = Min to Max	-	8	20	mA
Standby Power Supply Current(2)	I <sub>SB1</sub>	CS ≥ V <sub>CC</sub> - 0.2V, V <sub>IN</sub> ≤ 0.2V or V <sub>IN</sub> ≥ V <sub>CC</sub> - 0.2V	-	20	800	μA
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 8mA	-	-	0.40	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -4mA	2.4	-	-	V

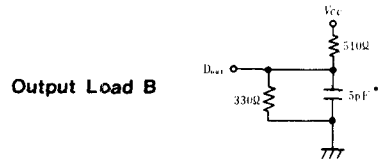
Note) 1. The operating ambient temperature range is guaranteed with transverse air flow exceeding 400 linear feet minute.  
2. Typical limits are at V<sub>CC</sub> = 5.0V, Ta = 25°C and specified loading.

AC TEST CONDITIONS

- Input pulse levels: GND to 3.0V
- Input rise and fall times: 5 ns
- Input timing reference levels: 1.5V
- Output load: See Figure
- Output timing reference levels: 1.5V (HM6147H/P-35)  
0.8 to 2.0V (HM6147H/P-45/55)



\* Including scope & jig capacitance



CAPACITANCE (Ta = 25°C, f = 1.0MHz)

Item	Symbol	Conditions	max	Unit
Input Capacitance	C <sub>in</sub>	V <sub>in</sub> = 0V	5	pF
Output Capacitance	C <sub>out</sub>	V <sub>out</sub> = 0V	6	pF

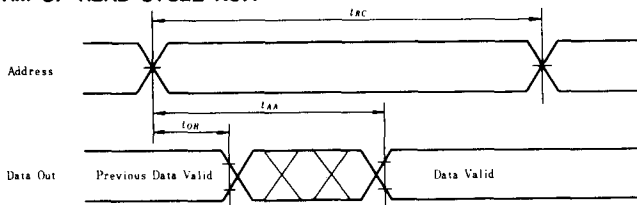
Note) This parameter is sampled and not 100% tested.

■ AC CHARACTERISTICS ( $T_a=0^\circ\text{C}$  to  $70^\circ\text{C}$ ,  $V_{CC}=5V\pm 10\%$ , unless otherwise noted.)

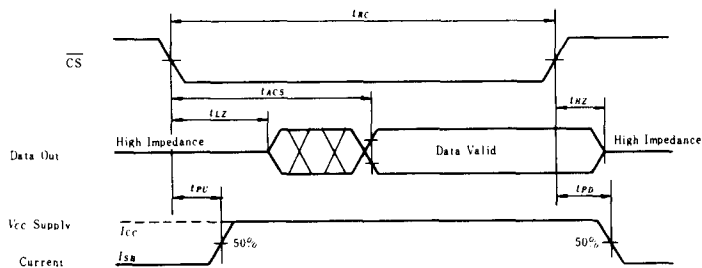
● READ CYCLE

Parameter	Symbol	HM6147H/P-35		HM6147H/P-45		HM6147H/P-55		Unit	Notes
		min	max	min	max	min	max		
Read Cycle Time	$t_{RC}$	35	—	45	—	55	—	ns	(1)
Address Access Time	$t_{AA}$	—	35	—	45	—	55	ns	
Chip Select Access Time	$t_{ACS}$	—	35	—	45	—	55	ns	
Output Hold from Address Change	$t_{OH}$	5	—	5	—	5	—	ns	
Chip Selection to Output in Low Z	$t_{LZ}$	5	—	5	—	5	—	ns	(2), (3), (7)
Chip Deselection to Output in High Z	$t_{HZ}$	0	30	0	30	0	30	ns	(2), (3), (7)
Chip Selection to Power Up Time	$t_{PU}$	0	—	0	—	0	—	ns	
Chip Deselection to Power Down Time	$t_{PD}$	—	20	—	20	—	20	ns	

● TIMING WAVEFORM OF READ CYCLE NO.1 <sup>(4) (5)</sup>



● TIMING WAVEFORM OF READ CYCLE NO.2 <sup>(4) (6)</sup>

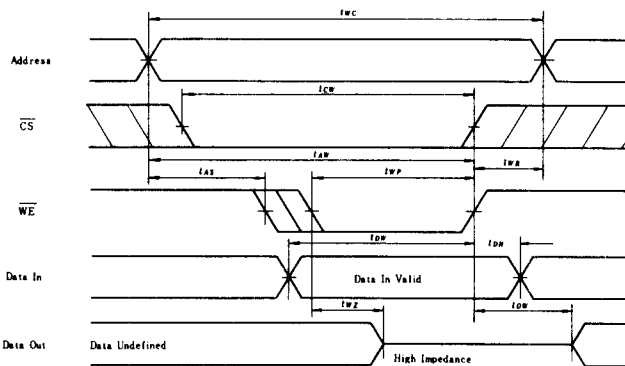


- Notes:
1. All Read Cycle timings are referenced from last valid address to the first transitioning address.
  2. At any given temperature and voltage condition,  $t_{HZ}$  max. is less than  $t_{LZ}$  min. both for a given device and from device to device.
  3. Transition is measured  $\pm 500\text{mV}$  from steady state voltage with specified loading in Load B.
  4.  $\overline{WE}$  is high for READ Cycle.
  5. Device is continuously selected,  $\overline{CS}=V_{IL}$ .
  6. Addresses valid prior to or coincident with  $\overline{CS}$  transition low.
  7. This parameter is sampled and not 100% tested.

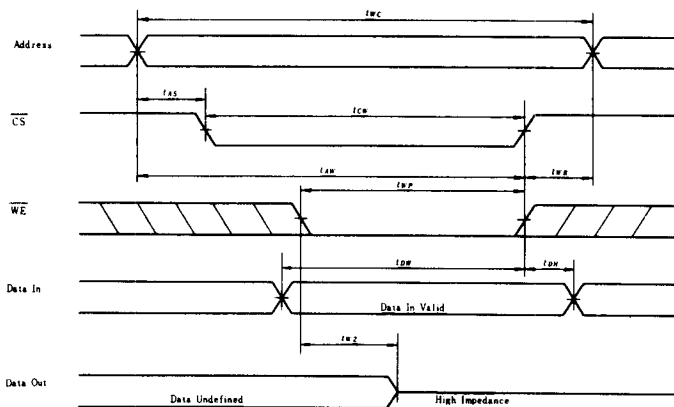
● WRITE CYCLE

Parameter	Symbol	HM6147H/P-35		HM6147H/P-45		HM6147H/P-55		Unit	Notes
		min	max	min	max	min	max		
Write Cycle Time	$t_{wc}$	35	—	45	—	55	—	ns	(2)
Chip Selection to End of Write	$t_{cw}$	35	—	45	—	45	—	ns	
Address Valid to End of Write	$t_{aw}$	35	—	45	—	45	—	ns	
Address Setup Time	$t_{as}$	0	—	0	—	0	—	ns	
Write Pulse Width	$t_{wp}$	20	—	25	—	30	—	ns	
Write Recovery Time	$t_{wr}$	0	—	0	—	0	—	ns	
Data Valid to End of Write	$t_{dw}$	20	—	25	—	25	—	ns	
Data Hold Time	$t_{dh}$	10	—	10	—	10	—	ns	
Write Enabled to Output in High Z	$t_{wz}$	0	20	0	25	0	30	ns	(3), (4)
Output Active from End of Write	$t_{ow}$	0	—	0	—	0	—	ns	(3), (4)

● TIMING WAVEFORM OF WRITE CYCLE (WE Controlled)



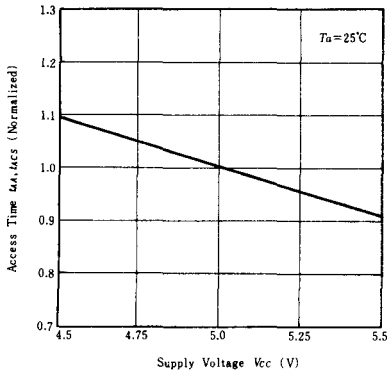
● TIMING WAVEFORM OF WRITE CYCLE (CS Controlled)



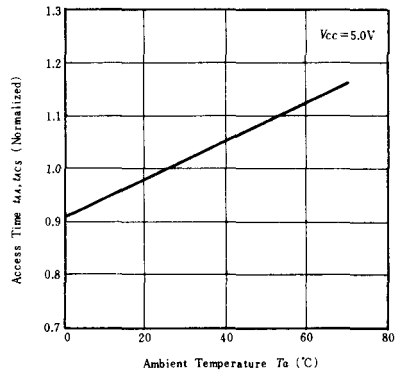
Note! CS or WE are High for Address Transition

- Notes:
1. If CS goes high simultaneously with WE high, the output remains in a high impedance states.
  2. All Write Cycle timings are referenced from the last valid address to the first transitioning address.
  3. Transition is measured  $\pm 500\text{mV}$  from steady state voltage with specified loading in Load B.
  4. This parameter is sampled and not 100% tested.

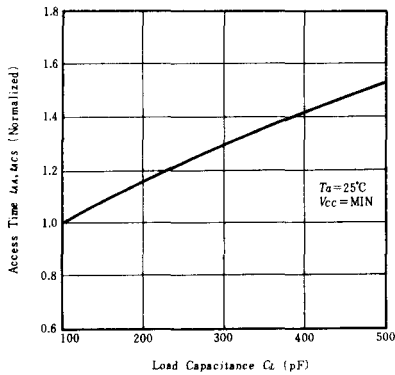
ACCESS TIME VS. SUPPLY VOLTAGE



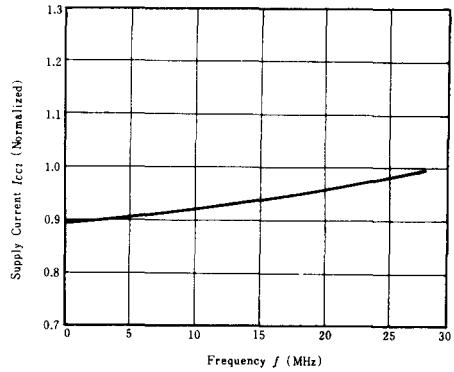
ACCESS TIME VS. AMBIENT TEMPERATURE



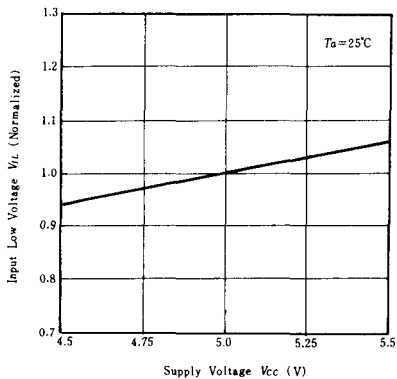
ACCESS TIME VS. LOAD CAPACITANCE



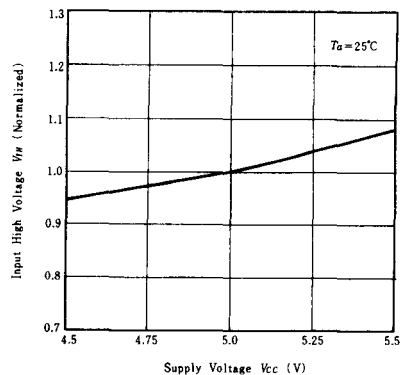
SUPPLY CURRENT VS. FREQUENCY



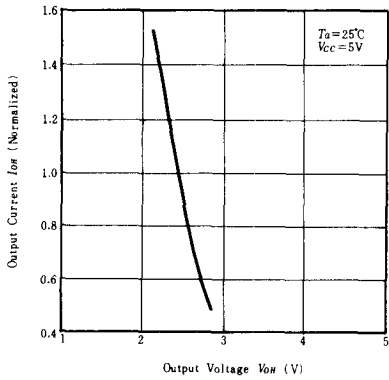
INPUT LOW VOLTAGE VS. SUPPLY VOLTAGE



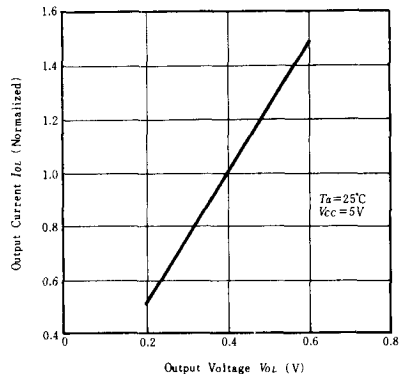
INPUT HIGH VOLTAGE VS. SUPPLY VOLTAGE



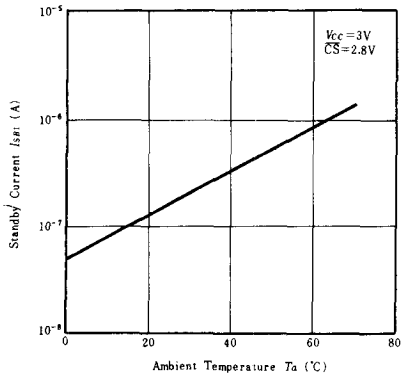
OUTPUT CURRENT VS. OUTPUT VOLTAGE



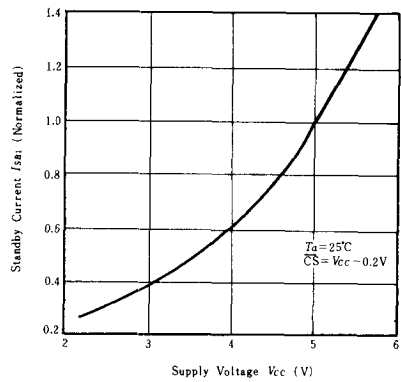
OUTPUT CURRENT VS. OUTPUT VOLTAGE



STANDBY CURRENT VS. AMBIENT TEMPERATURE



STANDBY CURRENT VS. SUPPLY VOLTAGE



STANDBY CURRENT VS. INPUT VOLTAGE

